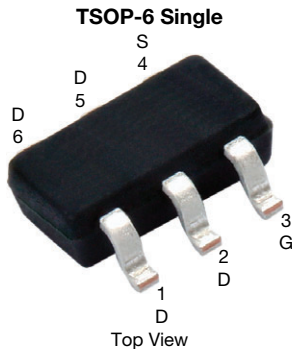


Automotive P-Channel 20 V (D-S) 175 °C MOSFET



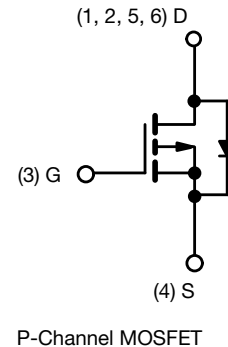
Marking Code: 9P

PRODUCT SUMMARY	
V_{DS} (V)	-20
$R_{DS(on)}$ (Ω) at $V_{GS} = -4.5$ V	0.060
$R_{DS(on)}$ (Ω) at $V_{GS} = -2.5$ V	0.100
I_D (A)	-7.4
Configuration	Single

FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE GRADE


RoHS
 COMPLIANT
 HALOGEN
FREE


ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free and halogen-free	SQ3425CEV (for detailed order number please see www.vishay.com/doc?79771)

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage	V_{DS}	-20	V		
Gate-source voltage	V_{GS}	± 12			
Continuous drain current	I_D	$T_C = 25$ °C	-7.4	A	
		$T_C = 125$ °C	-4.3		
Continuous source current (diode conduction)	I_S	-4.5	mJ		
Pulsed drain current ^a	I_{DM}	-29			
Single pulse avalanche current	I_{AS}	-11	W		
Single pulse avalanche energy	E_{AS}	6			
Maximum power dissipation	P_D	$T_C = 25$ °C	5	°C	
		$T_C = 125$ °C	1.67		
Operating junction and storage temperature range	T_J, T_{stg}	-55 to +175			

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	LIMIT	UNIT	
Junction-to-ambient	R_{thJA}	110	°C/W	
Junction-to-foot (drain)	R_{thJF}	30		

Notes

- Pulse test; pulse width ≤ 300 μ s, duty cycle ≤ 2 %
- When mounted on 1" square PCB (FR4 material)



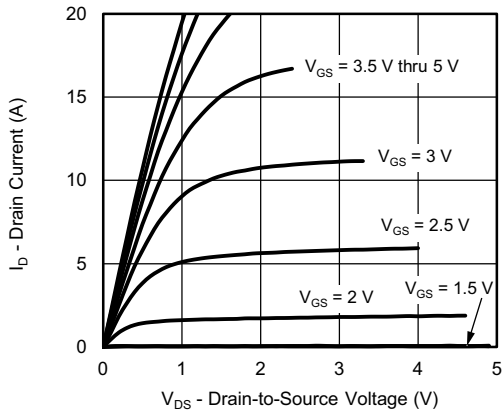
SPECIFICATIONS ($T_C = 25\text{ }^\circ\text{C}$, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0, I_D = -250\text{ }\mu\text{A}$	-20	-	-	V
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\text{ }\mu\text{A}$	-0.6	-1	-1.4	
Gate-source leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = \pm 12\text{ V}$	-	-	± 100	nA
Zero gate voltage drain current	I_{DSS}	$V_{GS} = 0\text{ V}, V_{DS} = -20\text{ V}$	-	-	-1	μA
		$V_{GS} = 0\text{ V}, V_{DS} = -20\text{ V}, T_J = 125\text{ }^\circ\text{C}$	-	-	-50	
		$V_{GS} = 0\text{ V}, V_{DS} = -20\text{ V}, T_J = 175\text{ }^\circ\text{C}$	-	-	-150	
On-state drain current ^a	$I_{D(on)}$	$V_{GS} = -4.5\text{ V}, V_{DS} \leq -5\text{ V}$	-15	-	-	A
Drain-source on-state resistance ^a	$R_{DS(on)}$	$V_{GS} = -4.5\text{ V}, I_D = -4.7\text{ A}$	-	0.049	0.060	Ω
		$V_{GS} = -4.5\text{ V}, I_D = -4.7\text{ A}, T_J = 125\text{ }^\circ\text{C}$	-	0.065	-	
		$V_{GS} = -4.5\text{ V}, I_D = -4.7\text{ A}, T_J = 175\text{ }^\circ\text{C}$	-	0.074	-	
		$V_{GS} = -2.5\text{ V}, I_D = -1\text{ A}$	-	0.089	0.100	
Forward transconductance ^a	g_{fs}	$V_{DS} = -10\text{ V}, I_D = -4.7\text{ A}$	-	9	-	S
Dynamic ^b						
Input capacitance	C_{iss}	$V_{GS} = 0\text{ V}, V_{DS} = -10\text{ V}, f = 1\text{ MHz}$	-	564	840	μF
Output capacitance	C_{oss}		-	162	267	
Reverse transfer capacitance	C_{rss}		-	120	190	
Total gate charge ^c	Q_g	$V_{GS} = -4.5\text{ V}, V_{DS} = -10\text{ V}, I_D = -4.7\text{ A}$	-	7.4	10.3	nC
Gate-source charge ^c	Q_{gs}		-	1.5	-	
Gate-drain charge ^c	Q_{gd}		-	2.7	-	
Gate resistance	R_g	$f = 1\text{ MHz}$	3	6.3	9.1	Ω
Turn-on delay time ^c	$t_{d(on)}$	$V_{DD} = -10\text{ V}, R_L = 10\text{ }\Omega, I_D \cong -1\text{ A}, V_{GEN} = -4.5\text{ V}, R_g = 6\text{ }\Omega$	-	11	15	ns
Rise time ^c	t_r		-	26	35	
Turn-off delay time ^c	$t_{d(off)}$		-	41	55	
Fall time ^c	t_f		-	28	38	
Source-Drain Diode Ratings and Characteristics ^b						
Pulsed current ^a	I_{SM}		-	-	-21	A
Forward voltage	V_{SD}	$I_F = -1.7\text{ A}, V_{GS} = 0\text{ V}$	-	-0.8	-1.2	V
Body diode reverse recovery time	t_{rr}	$I_F = -1.5\text{ A}, di/dt = 100\text{ A}/\mu\text{s}$	-	18	36	ns
Body diode reverse recovery charge	Q_{rr}		-	8	16	nC
Reverse recovery fall time	t_a		-	6	-	ns
Reverse recovery rise time	t_b		-	12	-	
Body diode peak reverse recovery current	$I_{RM(REC)}$			-	-0.86	-

Notes

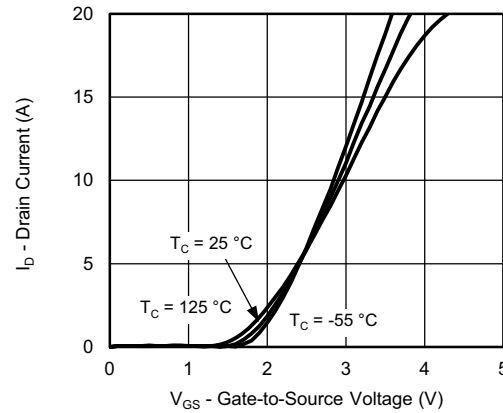
- Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
- Guaranteed by design, not subject to production testing
- Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

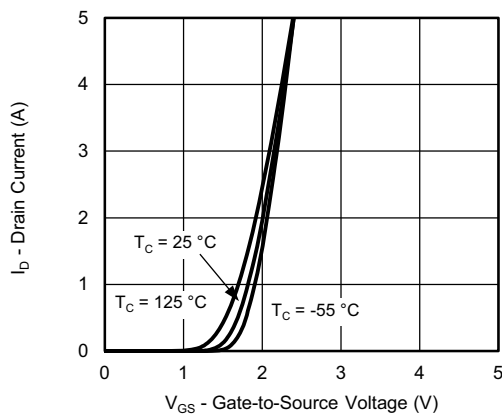
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)



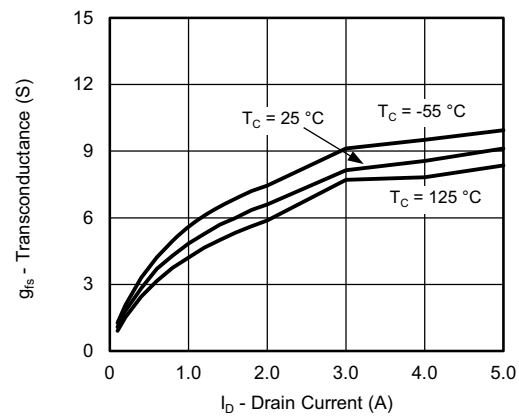
Output Characteristics



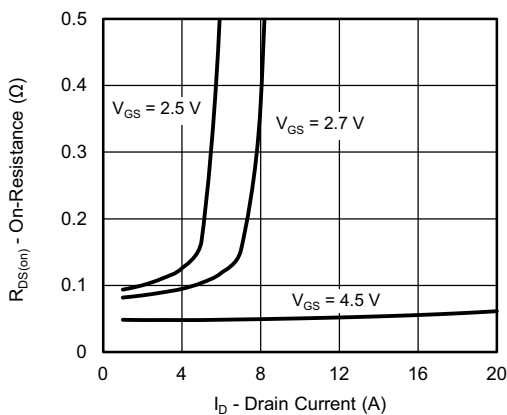
Transfer Characteristics



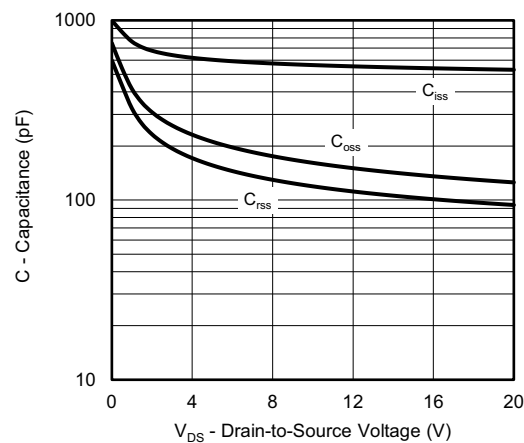
Transfer Characteristics



Transconductance



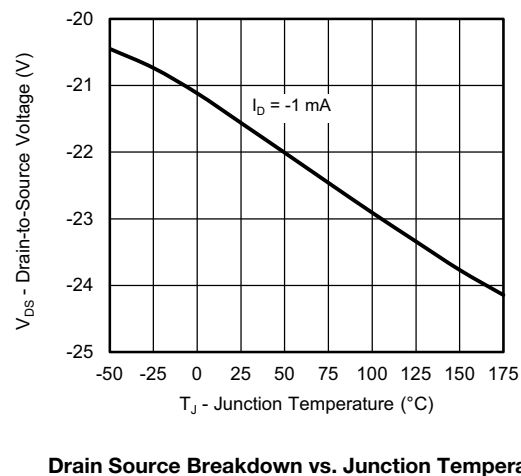
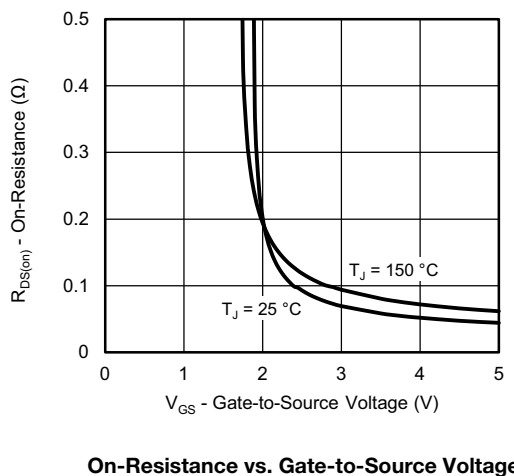
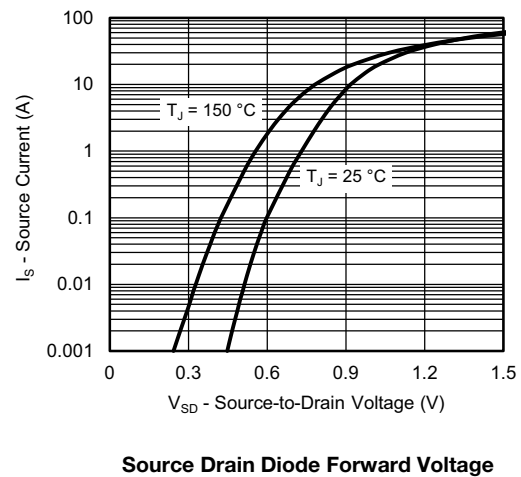
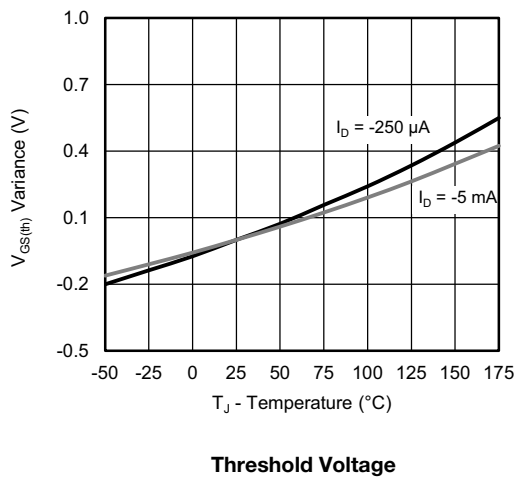
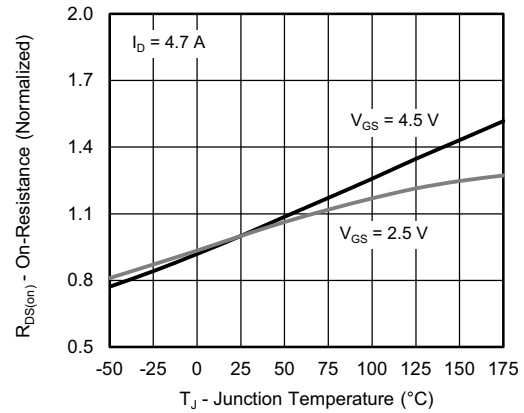
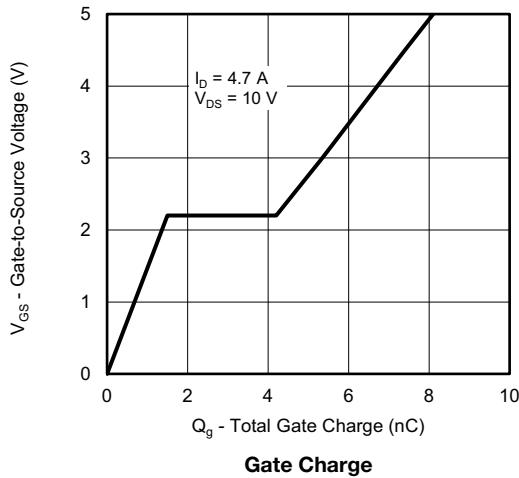
On-Resistance vs. Drain Current



Capacitance

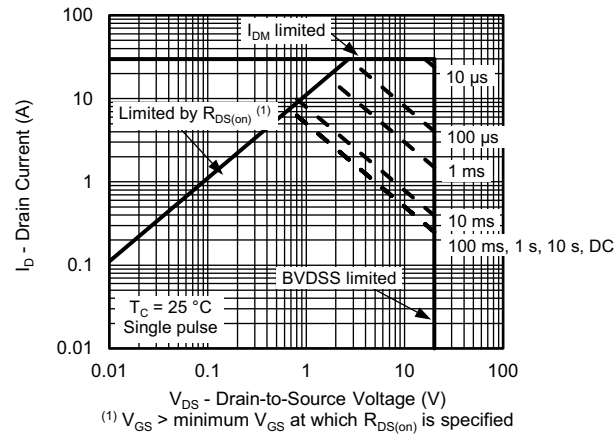


TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

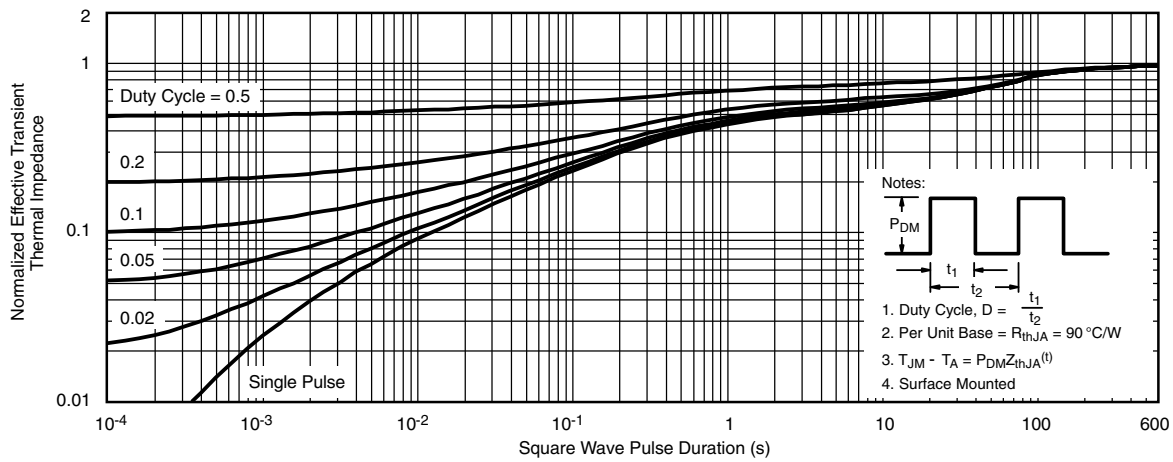




THERMAL RATINGS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)



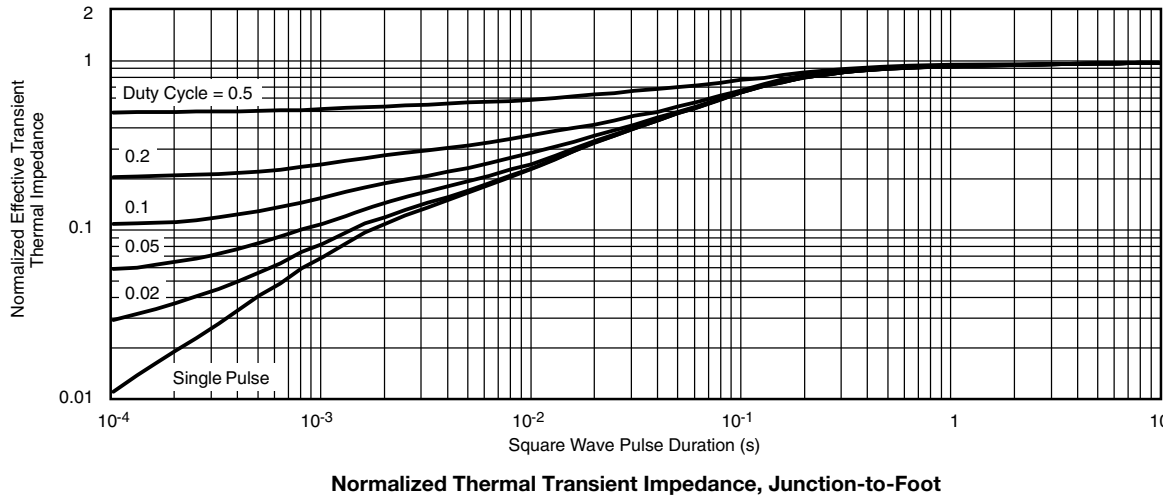
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)



Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient ($25\text{ }^\circ\text{C}$)
 - Normalized Transient Thermal Impedance Junction-to-Case ($25\text{ }^\circ\text{C}$)
- are given for general guidelines only to enable the user to get a “ball park” indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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